

Title (en)

Aqueous acid solutions for the electrodeposition of tin and/or lead/tin alloys.

Title (de)

Wässrige, saure Lösungen für die elektrolytische Abscheidung von Zinn und/oder Blei/Zinnlegierungen.

Title (fr)

Solutions aqueuses, acides pour le dépôt électrolytique d'étain et/ou d'alliages plomb/étain.

Publication

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Application

**EP 90100870 A 19900117**

Priority

DE 3902042 A 19890125

Abstract (en)

[origin: EP0379948A2] A description is given of aqueous acid solutions for the electrodeposition of tin and/or lead/tin alloys to improve electroplating in the high current density range and obtain uniform lustre throwing power in metals deposited in the low current density range. The solutions according to the invention contain a mixture of metal salts, free alkanesulphonic acid, nonionic wetting agents and, optionally, aromatic short-chain aldehydes and/or, optionally, aromatic ketones and/or, optionally, short-chain unsaturated carboxylic acids. The solutions according to the invention are therefore characterised in that tin and/or lead salts of the alkanesulphonic acid are used as metal salts, the alkyl group of the alkanesulphonic acid consisting of 1 to 5 carbon atoms, and the free alkanesulphonic acid containing alkyl groups with 1 to 5 carbon atoms. As a further brightener, the solutions contain a mixture of a reaction product of acetaldehyde and/or its aldol condensation products with ammonia and/or acyclic ketones and/or aliphatic amines, amides, amino acids and/or hydrazine compounds.

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